



# LED Packaging for Lighting Applications: Design, Manufacturing, and Testing

By Sheng Liu, Xiaobing Luo

Download now

Read Online 

## LED Packaging for Lighting Applications: Design, Manufacturing, and Testing By Sheng Liu, Xiaobing Luo

Since the first light-emitting diode (LED) was invented by Holonyak and Bevacqua in 1962, LEDs have made remarkable progress in the past few decades with the rapid development of epitaxy growth, chip design and manufacture, packaging structure, processes, and packaging materials. LEDs have superior characteristics such as high efficiency, small size, long life, low power consumption, and high reliability. The market for white LED is growing rapidly in various applications. It has been widely accepted that white LEDs will be the fourth illumination source to substitute the incandescent, fluorescent, and high-pressure sodium lamps. With the development of LED chip and packaging technologies, the efficiency of high power white LED will broaden the application markets of LEDs while changing the lighting concepts of our lives.

In *LED Packaging for Lighting Applications*, Professors Liu and Luo cover the full spectrum of design, manufacturing, and testing. Many concepts are proposed for the first time, and readers will benefit from the concurrent engineering and co-design approaches to advanced engineering design of LED products.

- One of the only books to cover LEDs from package design to manufacturing to testing
- Focuses on the design of LED packaging and its applications such as road lights
- Includes design methods and experiences necessary for LED engineers, especially optical and thermal design
- Introduces novel LED packaging structures and manufacturing processes, such as ASLP
- Covers reliability considerations, the most challenging problem for the LED industry
- Provides measurement and testing standards, which are critical for LED development, for both LED and LED fixtures
- Codes and demonstrations available from the book's Companion Website

This book is ideal for practicing engineers working in design or packaging at LED companies and graduate students preparing for work in industry. This book also provides a helpful introduction for advanced undergraduates, graduates,

researchers, lighting designers, and product managers interested in the fundamentals of LED design and production.

Color version of selected figures can be found at [www.wiley.com/go/liu/led](http://www.wiley.com/go/liu/led)

 [Download LED Packaging for Lighting Applications: Design, M ...pdf](#)

 [Read Online LED Packaging for Lighting Applications: Design, ...pdf](#)

# LED Packaging for Lighting Applications: Design, Manufacturing, and Testing

By Sheng Liu, Xiaobing Luo

**LED Packaging for Lighting Applications: Design, Manufacturing, and Testing** By Sheng Liu, Xiaobing Luo

Since the first light-emitting diode (LED) was invented by Holonyak and Bevacqua in 1962, LEDs have made remarkable progress in the past few decades with the rapid development of epitaxy growth, chip design and manufacture, packaging structure, processes, and packaging materials. LEDs have superior characteristics such as high efficiency, small size, long life, low power consumption, and high reliability. The market for white LED is growing rapidly in various applications. It has been widely accepted that white LEDs will be the fourth illumination source to substitute the incandescent, fluorescent, and high-pressure sodium lamps. With the development of LED chip and packaging technologies, the efficiency of high power white LED will broaden the application markets of LEDs while changing the lighting concepts of our lives.

In *LED Packaging for Lighting Applications*, Professors Liu and Luo cover the full spectrum of design, manufacturing, and testing. Many concepts are proposed for the first time, and readers will benefit from the concurrent engineering and co-design approaches to advanced engineering design of LED products.

- One of the only books to cover LEDs from package design to manufacturing to testing
- Focuses on the design of LED packaging and its applications such as road lights
- Includes design methods and experiences necessary for LED engineers, especially optical and thermal design
- Introduces novel LED packaging structures and manufacturing processes, such as ASLP
- Covers reliability considerations, the most challenging problem for the LED industry
- Provides measurement and testing standards, which are critical for LED development, for both LED and LED fixtures
- Codes and demonstrations available from the book's Companion Website

This book is ideal for practicing engineers working in design or packaging at LED companies and graduate students preparing for work in industry. This book also provides a helpful introduction for advanced undergraduates, graduates, researchers, lighting designers, and product managers interested in the fundamentals of LED design and production.

Color version of selected figures can be found at [www.wiley.com/go/liu/led](http://www.wiley.com/go/liu/led)

**LED Packaging for Lighting Applications: Design, Manufacturing, and Testing** By Sheng Liu, Xiaobing Luo **Bibliography**

- Sales Rank: #983447 in Books
- Published on: 2011-07-05
- Original language: English
- Number of items: 1
- Dimensions: 9.90" h x .95" w x 6.90" l, 1.80 pounds

- Binding: Hardcover
- 376 pages

 [Download LED Packaging for Lighting Applications: Design, M ...pdf](#)

 [Read Online LED Packaging for Lighting Applications: Design, ...pdf](#)

## Download and Read Free Online LED Packaging for Lighting Applications: Design, Manufacturing, and Testing By Sheng Liu, Xiaobing Luo

---

### Editorial Review

#### Review

"The book will be useful as a resource for engineers in LED design or packaging, and as an introduction to the field for advanced students, researchers, lighting designers, and product managers." (Book News, 1 October 2011)

#### From the Back Cover

Since the first light-emitting diode (LED) was invented by Holonyak and Bevacqua in 1962, LEDs have made remarkable progress in the past few decades with the rapid development of epitaxy growth, chip design and manufacture, packaging structure, processes, and packaging materials. LEDs have superior characteristics such as high efficiency, small size, long life, low power consumption, and high reliability. The market for white LED is growing rapidly in various applications. It has been widely accepted that white LEDs will be the fourth illumination source to substitute the incandescent, fluorescent, and high-pressure sodium lamps. With the development of LED chip and packaging technologies, the efficiency of high power white LED will broaden the application markets of LEDs while changing the lighting concepts of our lives.

In *LED Packaging for Lighting Applications*, Professors Liu and Luo cover the full spectrum of design, manufacturing, and testing. Many concepts are proposed for the first time, and readers will benefit from the concurrent engineering and co-design approaches to advanced engineering design of LED products.

- One of the only books to cover LEDs from package design to manufacturing to testing
- Focuses on the design of LED packaging and its applications such as road lights
- Includes design methods and experiences necessary for LED engineers, especially optical and thermal design
- Introduces novel LED packaging structures and manufacturing processes, such as ASLP
- Covers reliability considerations, the most challenging problem for the LED industry
- Provides measurement and testing standards, which are critical for LED development, for both LED and LED fixtures
- Codes and demonstrations available from the book's Companion Website

This book is ideal for practicing engineers working in design or packaging at LED companies and graduate students preparing for work in industry. This book also provides a helpful introduction for advanced undergraduates, graduates, researchers, lighting designers, and product managers interested in the fundamentals of LED design and production.

Color version of selected figures can be found at [www.wiley.com/go/liu/led](http://www.wiley.com/go/liu/led)

#### About the Author

**Sheng Liu** is a ChangJiang Professor of Mechanical Engineering at Huazhong University of Science and Technology. He holds a dual appointment at Wuhan National Laboratory for Optoelectronics, and has served as tenured faculty at Wayne State University. He has over 14 years experience in LED/MEMS/IC packaging and extensive experience in consulting with many leading multi-national and Chinese companies. Liu was

awarded the White House/NSF Presidential Faculty Fellowship in 1995, ASME Young Engineer Award in 1996, and China NSFC Overseas Young Scientist in 1999. He has been an associate editor for IEEE Trans. On Electronic Packaging Manufacturing since 1999 and an associate editor of Journal of Frontiers of Optoelectronics in China since 2007. He is currently one of the 11 National Committee Members in LED under Ministry of Science and Technology. He obtained a Ph.D. from Stanford in 1992, and got MS and BS in flight vehicle design, Nanjing University of Aeronautics and Astronautics, and he had three years industrial experience in China and USA. He has filed more than 70 patents in China and the USA, and has published more than 300 technical articles.

**Xiaobing Luo** is a professor at Huazhong University of Science and Technology, Wuhan, China, with appointments at the School of Energy and Power Engineering and Wuhan National Lab for Optoelectronics. He received his Ph.D. in 2002 from Tsinghua University, China. He has also worked in Samsung Electronics in Korea as a Senior Engineer. His main research interests are LED, heat and mass transfer, microfluidics, MEMS, and sensors and actuators. He has published more than 60 papers and has applied for 40 patents in the USA, Korea, Japan, Europe and China.

## **Users Review**

### **From reader reviews:**

#### **Caroline Petrie:**

Have you spare time for a day? What do you do when you have far more or little spare time? Yep, you can choose the suitable activity with regard to spend your time. Any person spent their spare time to take a wander, shopping, or went to the Mall. How about open or perhaps read a book titled LED Packaging for Lighting Applications: Design, Manufacturing, and Testing? Maybe it is to become best activity for you. You understand beside you can spend your time together with your favorite's book, you can more intelligent than before. Do you agree with its opinion or you have different opinion?

#### **Gregory Mendoza:**

This LED Packaging for Lighting Applications: Design, Manufacturing, and Testing are usually reliable for you who want to be described as a successful person, why. The explanation of this LED Packaging for Lighting Applications: Design, Manufacturing, and Testing can be one of several great books you must have is definitely giving you more than just simple studying food but feed a person with information that perhaps will shock your prior knowledge. This book is definitely handy, you can bring it everywhere you go and whenever your conditions both in e-book and printed types. Beside that this LED Packaging for Lighting Applications: Design, Manufacturing, and Testing forcing you to have an enormous of experience such as rich vocabulary, giving you trial of critical thinking that could it useful in your day action. So , let's have it appreciate reading.

#### **Patricia Frazier:**

People live in this new day of lifestyle always try and and must have the free time or they will get lots of stress from both lifestyle and work. So , whenever we ask do people have extra time, we will say absolutely indeed. People is human not just a robot. Then we request again, what kind of activity do you have when the

spare time coming to a person of course your answer will certainly unlimited right. Then ever try this one, reading ebooks. It can be your alternative within spending your spare time, the actual book you have read is usually LED Packaging for Lighting Applications: Design, Manufacturing, and Testing.

**Dennis Haney:**

In this period of time globalization it is important to someone to acquire information. The information will make a professional understand the condition of the world. The condition of the world makes the information much easier to share. You can find a lot of sources to get information example: internet, classifieds, book, and soon. You can see that now, a lot of publisher in which print many kinds of book. The book that recommended for your requirements is LED Packaging for Lighting Applications: Design, Manufacturing, and Testing this publication consist a lot of the information on the condition of this world now. This particular book was represented so why is the world has grown up. The dialect styles that writer value to explain it is easy to understand. The actual writer made some research when he makes this book. That is why this book suitable all of you.

**Download and Read Online LED Packaging for Lighting Applications: Design, Manufacturing, and Testing By Sheng Liu, Xiaobing Luo #J26L587T9D3**

# **Read LED Packaging for Lighting Applications: Design, Manufacturing, and Testing By Sheng Liu, Xiaobing Luo for online ebook**

LED Packaging for Lighting Applications: Design, Manufacturing, and Testing By Sheng Liu, Xiaobing Luo Free PDF download, audio books, books to read, good books to read, cheap books, good books, online books, books online, book reviews epub, read books online, books to read online, online library, greatbooks to read, PDF best books to read, top books to read LED Packaging for Lighting Applications: Design, Manufacturing, and Testing By Sheng Liu, Xiaobing Luo books to read online.

## **Online LED Packaging for Lighting Applications: Design, Manufacturing, and Testing By Sheng Liu, Xiaobing Luo ebook PDF download**

**LED Packaging for Lighting Applications: Design, Manufacturing, and Testing By Sheng Liu, Xiaobing Luo Doc**

**LED Packaging for Lighting Applications: Design, Manufacturing, and Testing By Sheng Liu, Xiaobing Luo Mobipocket**

**LED Packaging for Lighting Applications: Design, Manufacturing, and Testing By Sheng Liu, Xiaobing Luo EPub**